PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KING WAI CHIU LAI	02/18/2020
XIAOTING LI	02/18/2020

RECEIVING PARTY DATA

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State/Country:	HONG KONG	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16720208

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ATTORNEY DOCKET NUMBER:	MKC.P.433	
NAME OF SUBMITTER:	MARK L. WEBER	
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DATE SIGNED:	03/02/2020	

Total Attachments: 1

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PATENT 505943771 REEL: 051976 FRAME: 0461

Assignment

In Consideration of good and valuable consideration provided to the undersigned by the Assignee, City University of Hong Kong, 83 Tat Chee Avenue, Kowloon, Hong Kong, the receipt of which is hereby acknowledged, the undersigned by these presents hereby sold, assigned, transferred and set over unto the said Assignee the entire right, title and interest in and to the improvement in:

AN ELECTROMECHANICAL SENSOR, A METHOD OF PRODUCING SUCH SENSOR AND A WEARABLE DEVICE INCLUDING SUCH SENSOR

said invention being fully described and/or claimed in the application for Letters Patent of the United States of America in and for the United States and all foreign countries and all additional and divisional applications thereof, the same to be held and enjoyed by said Assignee, his successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patents therefore may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries of its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said Assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefore in said Assignee, his successors, assigns or other legal representatives and upon the request and at the expense of said Assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of said Letters Patents to be granted therefore, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein without further compensation, but at the expense of said Assignee, his successors, assigns or other legal representatives.

And The Commissioner of Patents is Hereby Authorized and Requested to issue any and all Letters Patents of the United States for said invention, to said Assignee.

Signed and sealed:	
76 6	18/2/2020
LAI, King Wai Chiu	Date ,
LI Liartins	18/02/2020
Ul, Xiaoting	Date